

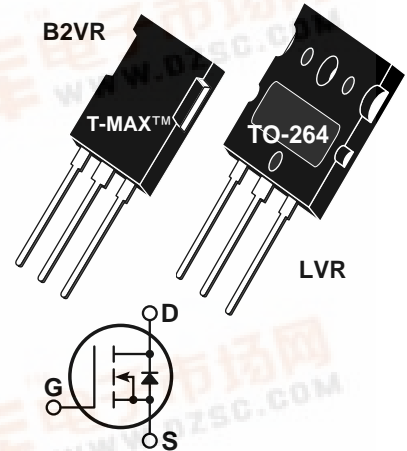


APT50M80B2VR APT50M80LVR

500V 58A 0.080Ω

POWER MOS V[®]

Power MOS V[®] is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V[®] also achieves faster switching speeds through optimized gate layout.



- Identical Specifications: T-MAX™ or TO-264 Package
- Faster Switching
- Lower Leakage
- 100% Avalanche Tested

MAXIMUM RATINGS

All Ratings: T_C = 25°C unless otherwise specified.

| Symbol | Parameter | APT50M80 | UNIT |
|-----------------------------------|--|------------|-------|
| V _{DSS} | Drain-Source Voltage | 500 | Volts |
| I _D | Continuous Drain Current @ T _C = 25°C | 58 | Amps |
| I _{DM} | Pulsed Drain Current ^① | 232 | |
| V _{GS} | Gate-Source Voltage Continuous | ±30 | Volts |
| V _{GSM} | Gate-Source Voltage Transient | ±40 | |
| P _D | Total Power Dissipation @ T _C = 25°C | 625 | Watts |
| | Linear Derating Factor | 5.0 | W/°C |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | -55 to 150 | °C |
| T _L | Lead Temperature: 0.063" from Case for 10 Sec. | 300 | |
| I _{AR} | Avalanche Current ^① (Repetitive and Non-Repetitive) | 58 | Amps |
| E _{AR} | Repetitive Avalanche Energy ^① | 50 | mJ |
| E _{AS} | Single Pulse Avalanche Energy ^④ | 3000 | |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|---|-----|-----|-------|-------|
| BV _{DSS} | Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 250μA) | 500 | | | Volts |
| I _{D(on)} | On State Drain Current ^② (V _{DS} > I _{D(on)} × R _{DS(on)} Max, V _{GS} = 10V) | 58 | | | Amps |
| R _{DS(on)} | Drain-Source On-State Resistance ^② (V _{GS} = 10V, 0.5 I _{D[Cont.]}) | | | 0.080 | Ohms |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{DS} = V _{DSS} , V _{GS} = 0V) | | | 25 | μA |
| | Zero Gate Voltage Drain Current (V _{DS} = 0.8 V _{DSS} , V _{GS} = 0V, T _C = 125°C) | | | 250 | |
| I _{GSS} | Gate-Source Leakage Current (V _{GS} = ±30V, V _{DS} = 0V) | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 2.5mA) | 2 | | 4 | Volts |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

DYNAMIC CHARACTERISTICS

APT50M80 B2VR - LVR

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|--------------|--------------------------------|--|-----|------|-----|------|
| C_{iss} | Input Capacitance | $V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1 \text{ MHz}$ | | 8630 | | pF |
| C_{oss} | Output Capacitance | | | 1160 | | |
| C_{rss} | Reverse Transfer Capacitance | | | 440 | | |
| Q_g | Total Gate Charge ^③ | $V_{GS} = 10V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = 0.5 I_{D[Cont.]} @ 25^\circ C$ | | 360 | | nC |
| Q_{gs} | Gate-Source Charge | | | 57 | | |
| Q_{gd} | Gate-Drain ("Miller") Charge | | | 151 | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{GS} = 15V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_{D[Cont.]} @ 25^\circ C$ $R_G = 0.6\Omega$ | | 16 | | ns |
| t_r | Rise Time | | | 18 | | |
| $t_{d(off)}$ | Turn-off Delay Time | | | 60 | | |
| t_f | Fall Time | | | 6 | | |

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|----------|---|-----|------|-----|---------|
| I_S | Continuous Source Current (Body Diode) | | | 58 | Amps |
| I_{SM} | Pulsed Source Current ^① (Body Diode) | | | 232 | |
| V_{SD} | Diode Forward Voltage ^② ($V_{GS} = 0V, I_S = -I_{D[Cont.]}$) | | | 1.3 | Volts |
| t_{rr} | Reverse Recovery Time ($I_S = -I_{D[Cont.]}, di_S/dt = 100A/\mu s$) | | 680 | | ns |
| Q_{rr} | Reverse Recovery Charge ($I_S = -I_{D[Cont.]}, di_S/dt = 100A/\mu s$) | | 17.0 | | μC |

THERMAL CHARACTERISTICS

| Symbol | Characteristic | MIN | TYP | MAX | UNIT |
|-----------------|---------------------|-----|-----|------|--------------|
| $R_{\theta JC}$ | Junction to Case | | | 0.20 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction to Ambient | | | 40 | |

① Repetitive Rating: Pulse width limited by maximum junction temperature.

③ See MIL-STD-750 Method 3471

② Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

④ Starting $T_j = +25^\circ C, L = 1.78mH, R_G = 25\Omega, \text{Peak } I_L = 58A$

APT Reserves the right to change, without notice, the specifications and information contained herein.

